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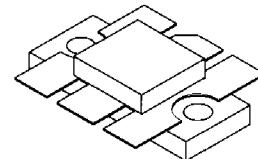
The RF Line **NPN Silicon** **RF Power Transistor**

. . . designed primarily for wideband large-signal output and driver amplifier stages in the 100 to 500 MHz frequency range.

- Specified 28 Volt, 400 MHz Characteristics —
Output Power = 100 Watts
Minimum Gain = 7.0 dB
Efficiency = 50% (Min)
- Built-In Matching Network for Broadband Operation Using Double Match Technique
- 100% Tested for Load Mismatch at all Phase Angles with 3:1 VSWR
- Gold Metallization System for High Reliability

MRF329

100 W, 100 to 500 MHz
CONTROLLED "Q"
BROADBAND RF POWER
TRANSISTOR
NPN SILICON



CASE 333-04, STYLE 1

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	V _{CEO}	30	Vdc
Collector-Base Voltage	V _{CBO}	60	Vdc
Emitter-Base Voltage	V _{EBO}	4.0	Vdc
Collector Current — Continuous — Peak	I _C	9.0 12	Adc
Total Device Dissipation @ T _C = 25°C (1) Derate above 25°C	P _D	270 1.54	Watts W/°C
Storage Temperature Range	T _{stg}	-65 to +150	°C

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case (2)	R _{θJC}	0.65	°C/W

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted.)

Characteristic	Symbol	Min	Typ	Max	Unit
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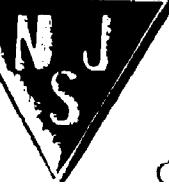
OFF CHARACTERISTICS

Collector-Emitter Breakdown Voltage (I _C = 80 mAdc, I _B = 0)	V(BR)CEO	30	—	—	Vdc
Collector-Emitter Breakdown Voltage (I _C = 80 mAdc, V _{BE} = 0)	V(BR)CES	60	—	—	Vdc
Emitter-Base Breakdown Voltage (I _E = 8.0 mAdc, I _C = 0)	V(BR)EBO	4.0	—	—	Vdc

NOTES:

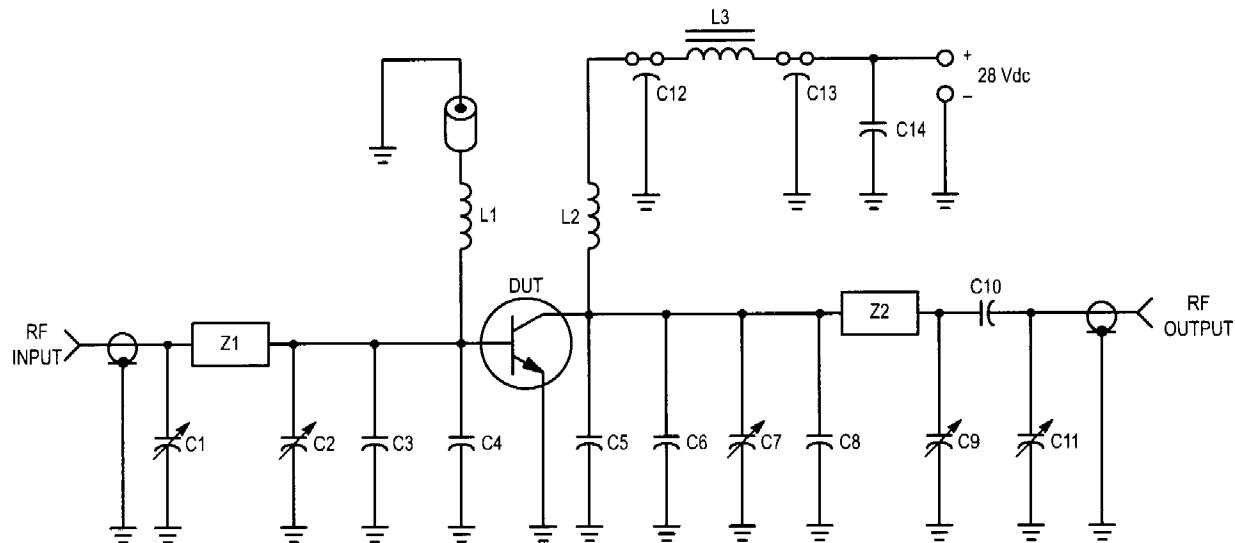
(continued)

1. This device is designed for RF operation. The total device dissipation rating applies only when the device is operated as an RF amplifier.
2. Thermal Resistance is determined under specified RF operating conditions by infrared measurement techniques.



ELECTRICAL CHARACTERISTICS — continued ($T_C = 25^\circ\text{C}$ unless otherwise noted.)

Characteristic	Symbol	Min	Typ	Max	Unit
OFF CHARACTERISTICS (continued)					
Collector-Base Breakdown Voltage ($I_C = 80 \text{ mA}_\text{dc}$, $I_E = 0$)	$V_{(\text{BR})\text{CBO}}$	60	—	—	V_dc
Collector Cutoff Current ($V_{CB} = 30 \text{ V}_\text{dc}$, $I_E = 0$)	I_{CBO}	—	—	5.0	mA_dc
ON CHARACTERISTICS					
DC Current Gain ($I_C = 4.0 \text{ Adc}$, $V_{CE} = 5.0 \text{ V}_\text{dc}$)	h_{FE}	20	—	80	—
DYNAMIC CHARACTERISTICS					
Output Capacitance ($V_{CB} = 28 \text{ V}_\text{dc}$, $I_E = 0$, $f = 1.0 \text{ MHz}$)	C_{ob}	—	95	125	pF
FUNCTIONAL TESTS (Figure 1)					
Common-Emitter Amplifier Power Gain ($V_{CC} = 28 \text{ V}_\text{dc}$, $P_{\text{out}} = 100 \text{ W}$, $f = 400 \text{ MHz}$)	G_{PE}	7.0	9.7	—	dB
Collector Efficiency ($V_{CC} = 28 \text{ V}_\text{dc}$, $P_{\text{out}} = 100 \text{ W}$, $f = 400 \text{ MHz}$)	η	50	60	—	%
Load Mismatch ($V_{CC} = 28 \text{ V}_\text{dc}$, $P_{\text{out}} = 100 \text{ W}$, $f = 400 \text{ MHz}$, VSWR = 3:1 all angles)	Ψ	No Degradation in Output Power			



C1, C2, C7, C9 — 1.0–20 pF Johanson (JMC 5501)

C3, C4 — 36 pF 100 mil Chip Cap (ATC)

C5, C6 — 50 pF 100 mil Chip Cap (ATC)

C8 — 30 pF 100 mil Chip Cap (ATC)

C10 — 2.0–150 pF 100 mil Chip Caps in Parallel (ATC)

C11 — 1.0–10 pF Johanson (JMC 5201)

C12, C13 — 1000 pF UNELCO Feedthru

C14 — 0.1 μF Erie Radcap

L1 — 0.15 μH Molded Choke with Ferrite Bead
(Ferroxcube #56-590-65/4B) on Ground End

L2 — 4 Turns #18 AWG, 1/4" ID

L3 — Ferroxcube VK200-19/4B

Z1 — Microstrip Line 2300 mils L x 210 mils W

Z2 — Microstrip Line 2300 mils L x 280 mils W

Board — Glass Teflon, $t = 0.062"$, $\epsilon_r = 2.56$

Figure 1. 400 MHz Test Circuit